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Renesas Electronics Corporation

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Serial EEPROM of HN58X25xxx Series

Control Using Clock Synchronous SCI of Renesas SH

Introduction

This document should be used for reference when implementing control of the HN58X25xxx Series serial EEPROM manufactured by Renesas Technology Corp., using the clock synchronous serial communication interface (hereafter referred to as SCI) of the SuperH family manufactured by Renesas Technology Corp.

The SuperH family incorporates a clock synchronous SCI. The HN58X25xxx Series serial EEPROM can be controlled through the clock synchronous SCI and software.

This document describes sample programs for controlling the HN58X25xxx Series serial EEPROM by using the clock synchronous SCI.

Target Device

The application examples described in this document are applicable when the following MCU and condition are used.

- MCU: SuperH family
- Condition: Clock synchronous SCI is used

The programs can be executed by any SuperH family MCU with the SCI. Note however that since some functions may be altered by function addition, etc., the functions should be confirmed against the MCU manual.

Be sure to perform evaluation sufficiently when using this application note.

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1. Control Method for HN58X25xxx Series Serial EEPROM

1.1 Overview of Operation

Control of the HN58X25xxx Series serial EEPROM is implemented by using the clock synchronous SCI in the SuperH. The connection method is described below.

The sample programs execute the following control operations.

- Connects the S# pin of the serial EEPROM to a SuperH port and controls it using output of the SuperH general port.
- Controls data input/output by the clock synchronous SCI (using the internal clock).

Refer to the data sheets of the MCU and serial EEPROM and specify a usable clock frequency.

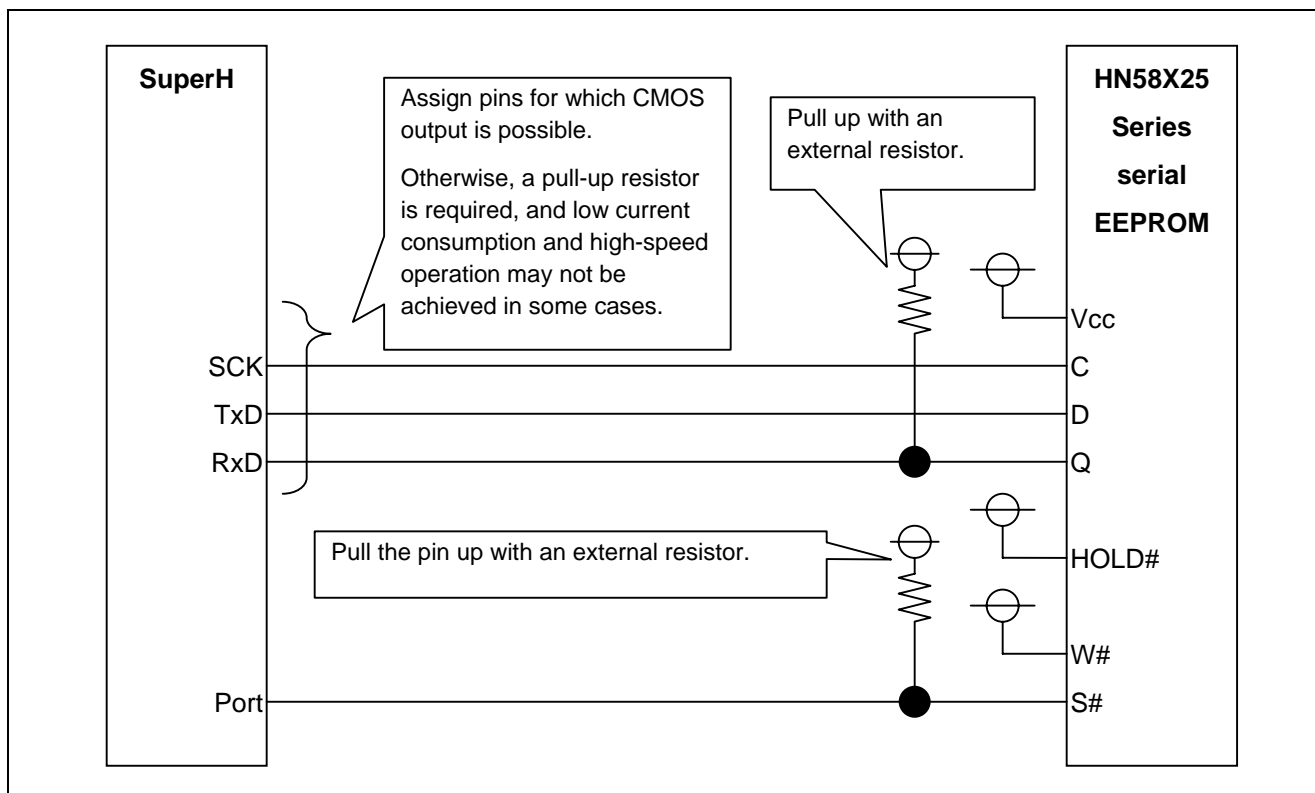


Figure 1.1 Serial EEPROM Connection Example

1.2 Signal Timing Generation of Clock Synchronous SCI

Signals are generated at the following timing to satisfy the serial EEPROM timing.

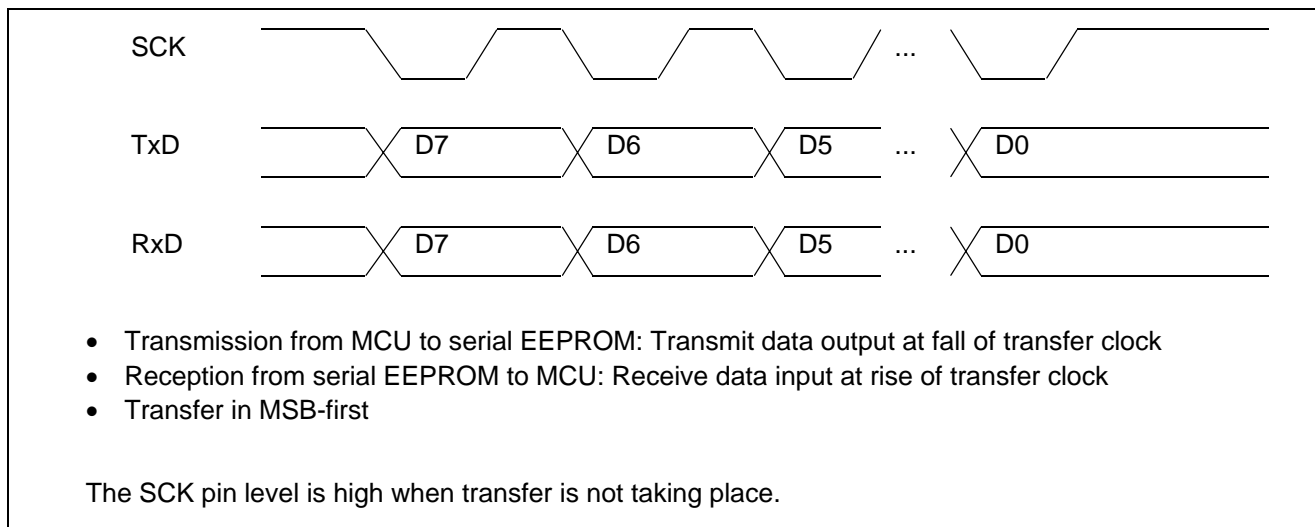


Figure 1.2 Timing for Clock Synchronous SCI of SuperH

Check the data sheets of the MCU and serial EEPROM for the maximum clock frequency that can be used.

1.3 Control of S# Pin of Serial EEPROM

The S# pin of the serial EEPROM is connected to a SuperH port and controlled using output of the SuperH general port.

The period from the falling edge of the S# pin (port of SuperH) of the serial EEPROM to the falling edge of the C pin (SCK of SuperH) is controlled by inserting software wait cycles.

The period from the rising edge of the C pin (SCK of SuperH) to the rising edge of the S# pin (port of SuperH) is controlled by inserting software wait cycles.

Check the data sheet of the serial EEPROM and set the software wait time according to the system.

1.4 MCU Hardware Resources in Use

The hardware resources to be used are shown below.

Table 1.1 Hardware Resources in Use

Resource in Use	Number of Used Resources
Clock synchronous SCI	One channel (essential)
Port (for control of the S# pin of serial EEPROM)	One port (essential)

MSB-first is specified for an MCU for which MSB-first is allowed.

Endian conversion is performed through software in an MCU that supports only LSB-first.

1.5 SuperH Register Setting (Clock Synchronous SCI)

Set up the clock synchronous SCI as shown below to satisfy the serial EEPROM specifications/timing.

A setting example in which the FIFO is not used is shown below.

1.5.1 SH7206

An example of setting the SCIF based on the register descriptions in the SH7206 Group Hardware Manual Rev. 1.00 is shown in the table below.

Table 1.2 Clock Synchronous SCI Mode Settings

Register	Bit	Function and Setting	
SCFRDR	7 to 0	The receive data is read from these bits.	
SCFTDR	7 to 0	Set the transmit data in these bits.	
SCSMR	15 to 8	Reserved These bits are always read as 0. The write value should always be 0.	
	C/A#	Write 1 to this bit (clock synchronous mode).	
	CHR	Write 0 to this bit. Since clock synchronous mode is selected, the data length is fixed at 8 bits.	
	PE	Write 0 to this bit. Since clock synchronous mode is selected, parity bit addition and checking is disabled	
	O/E#	Write 0 to this bit. Since clock synchronous mode is selected, this bit setting is invalid.	
	STOP	Write 0 to this bit. Since clock synchronous mode is selected, this bit setting is invalid.	
	2	Reserved This bit is always read as 0. The write value should always be 0.	
	CKS1, CKS0	Select the clock source in these bits.	
	SCSCR	15 to 8	Reserved These bits are always read as 0. The write value should always be 0.
		TIE	Write 0 to this bit.
RIE		Write 0 to this bit.	
TE		Write 1 to this bit at transmission and reception.	
RE		Write 1 to this bit at reception.	
REIE		Write 0 to this bit.	
2		Reserved This bit is always read as 0. The write value should always be 0.	
CKE1, CKE0		Write 00 to these bits (internal clock/SCK pin functions as input pin (input signal is ignored)).	

Register	Bit	Function and Setting
SCFSR	PER3 to PER0	The status is read from these bits.
	FER3 to FER0	The status is read from these bits.
	ER	The status is read from this bit. 0 is written to this bit at initialization.
	TEND	The status is read from this bit. 0 is written to this bit at initialization.
	TDFE	The status is read from this bit. 1 is written to this bit at initialization but it is not for the purpose of clearing this bit.
	BRK	The status is read from this bit. 0 is written to this bit at initialization.
	FER	The status is read from this bit.
	PER	The status is read from this bit.
	RDF	The status is read from this bit. 0 is written to this bit at initialization.
	DR	The status is read from this bit. 0 is written to this bit at initialization.
SCBRR	7 to 0	Set the transfer speed in these bits.
SCFCR	15 to 11	Reserved These bits are always read as 0. The write value should always be 0.
	RSTRG2 to RSTGR0	Write 000b to these bits.
	RTRG1, RTRG0	Write 00b to these bits.
	TTRG1, TTRG0	Write 11b to these bits.
	MCE	Write 0 to this bit.
	TFRST	1 is written to this bit at initialization. Write 0 to this bit at transmission and reception.
	RFRTST	1 is written to this bit at initialization. Write 0 to this bit at reception.
	LOOP	Write 0 to this bit.
SCFDR	15 to 13	Reserved These bits are always read as 0. The write value should always be 0.
	T4 to T0	These bits indicate the number of untransmitted data bytes.
	7 to 5	Reserved These bits are always read as 0. The write value should always be 0.
	R4 to R0	These bits indicate the number of receive data bytes.
SCSPTR	15 to 8	Reserved These bits are always read as 0. The write value should always be 0.
	RTSIO	0 is written to this bit at initialization.
	RTSDT	0 is written to this bit at initialization.
	CTSIO	0 is written to this bit at initialization.
	CTSDT	0 is written to this bit at initialization.
	SCKIO	0 is written to this bit at initialization.
	SCKDT	0 is written to this bit at initialization.
	SPB2IO	0 is written to this bit at initialization.
	SPB2DT	0 is written to this bit at initialization.

2. Sample Programs

Two or more of the same devices can be connected to the serial bus and controlled.

The sample programs execute the following:

- Data read processing
- Data write processing
- Write-protection processing through software protection
- Status read processing

2.1 Overview of Software Operations

The operations roughly described below are performed.

(1) The driver initialization processing acquires the resources to be used by the driver and initializes them.

At this point, the pins connected to the serial EEPROM are as follows:

S pin: The MCU is set to input mode

SCK pin: The MCU is set to input mode

TxD pin: The MCU is set to input mode

RxD pin: The MCU is set to input mode; high-level input by an external pull-up resistor

(2) Function calls perform the following operations.

1. Execute the processing of each function.

2. The pins connected to the serial EEPROM are as follows:

S pin: The MCU is set to input mode

SCK pin: The MCU is set to input mode

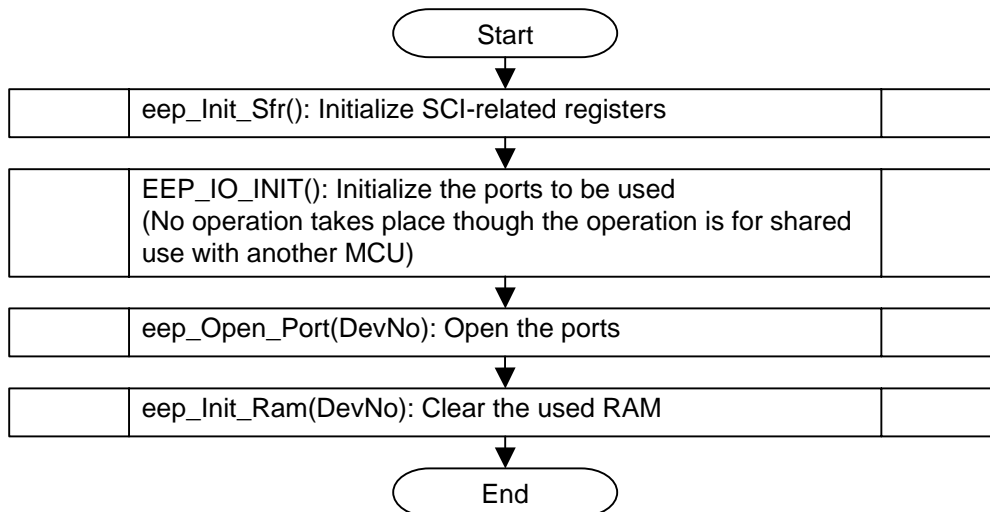
TxD pin: The MCU is set to input mode

RxD pin: The MCU is set to input mode; high-level input by an external pull-up resistor

2.2 Detailed Description of Functions

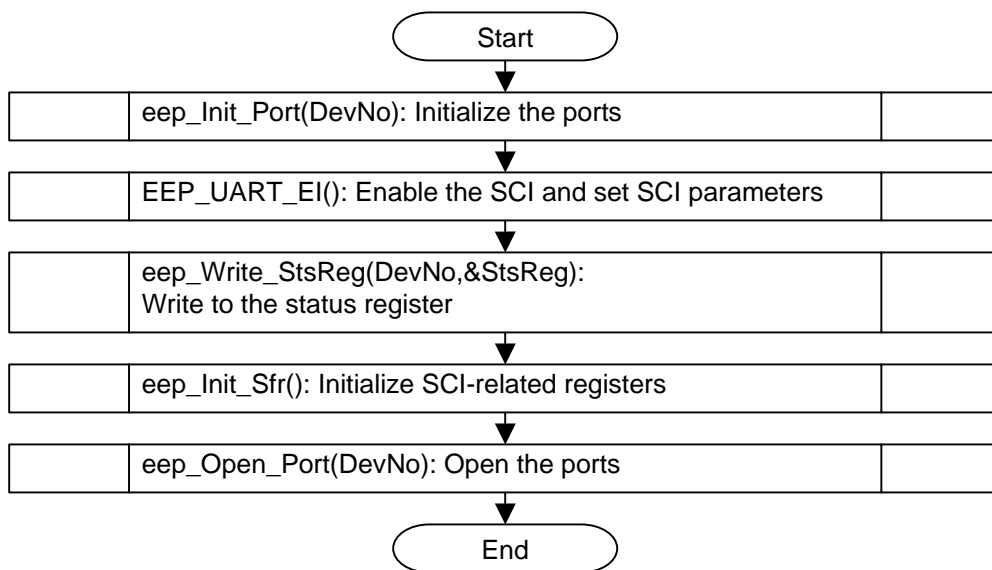
2.2.1 Driver Initialization Processing

Function Name
EEPROM driver initialization processing void eep_Init_Driver(void)
Arguments
None
Return Values
None
Operations
<ul style="list-style-type: none"> • Initializes the EEPROM driver. • Initializes the SFR for EEPROM control. • Performs the following processing for each device. <ul style="list-style-type: none"> (a) Opens the EEPROM control ports. (b) Initializes the EEPROM control RAM. • Call this function once at system activation.
Notes
None



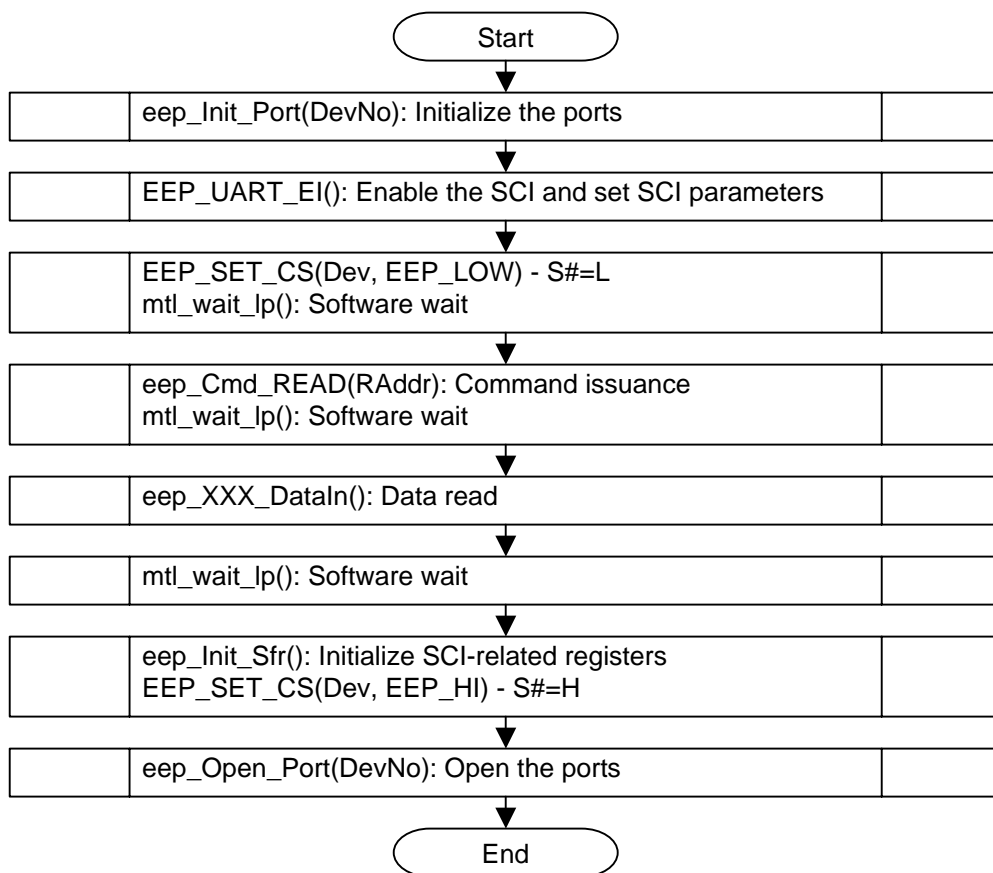
2.2.2 Write-Protection Setting Processing

Function Name	
Write-protection setting processing signed short eep_Write_Protect(unsigned char DevNo, unsigned char WpSts)	
Arguments	
unsigned char	DevNo ; Device number
unsigned char	WpSts ; Write-protection setting data
Return Values	
Returns the write-protection setting result.	
EEP_OK	; Successful operation
EEP_ERR_PARAM	; Parameter error
EEP_ERR_OTHER	; Other error
Operations	
<ul style="list-style-type: none"> • Makes the write-protection setting. • Set the write-protection setting data (WpSts) as follows: <ul style="list-style-type: none"> EEP_WP_NONE ; No protection EEP_WP_UPPER_QUART ; Upper-quarter protection setting EEP_WP_UPPER_HALF ; Upper-half protection setting EEP_WP_WHOLE_MEM ; Whole memory protection setting 	
Notes	
None	



2.2.3 Data Read Processing

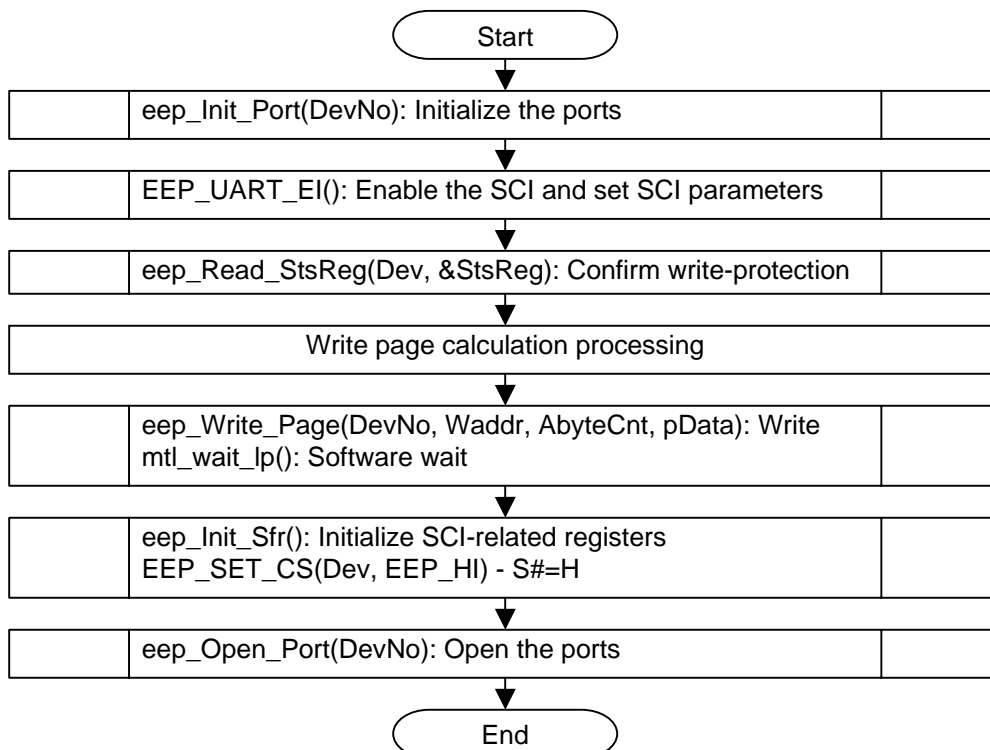
Function Name	
Data read processing signed short eep_Read_Data(unsigned char DevNo, unsigned short RAddr, unsigned short RCnt, unsigned char * pData)	
Arguments	
unsigned char	DevNo ; Device number
unsigned short	RAddr ; Read start address
unsigned short	RCnt ; Number of bytes to be read
unsigned char FAR*	pData ; Read data storage buffer pointer
Return Values	
Returns the read result.	
EEP_OK	; Successful operation
EEP_ERR_PARAM	; Parameter error
EEP_ERR_HARD	; Hardware error
EEP_ERR_OTHER	; Other error
Operations	
<ul style="list-style-type: none"> • Reads data from EEPROM in bytes. • Reads data from the specified address for the specified number of bytes. 	
Notes	
<ul style="list-style-type: none"> • The maximum write address is EEPROM size - 1. 	



2.2.4 Data Write Processing

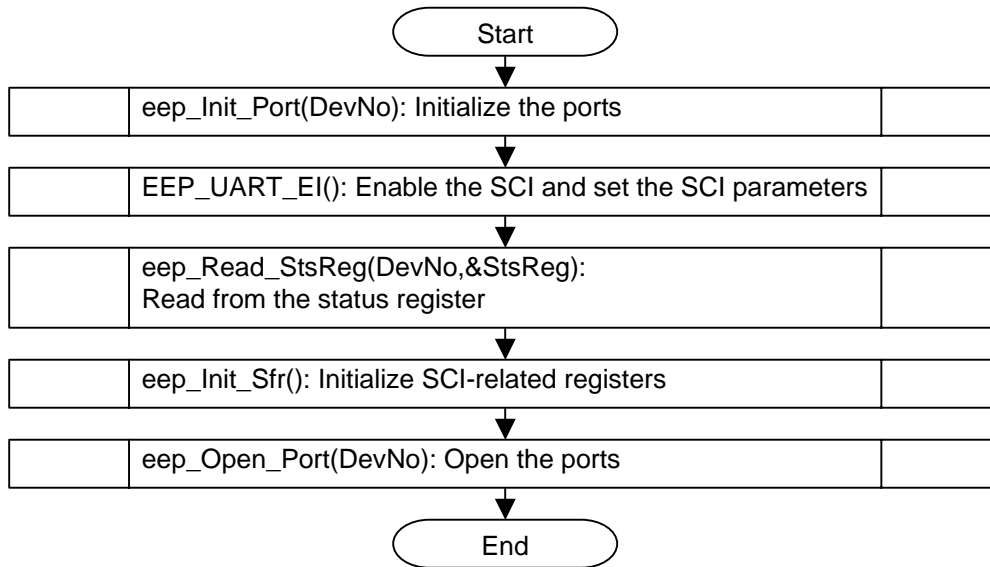
Function Name			
Data write processing signed short eep_Write_Data(unsigned char DevNo, unsigned short WAddr, unsigned short WCnt, unsigned char FAR* pData)			
Arguments			
unsigned char	DevNo	;	Device number
unsigned short	WAddr	;	Write start address
unsigned short	WCnt	;	Number of bytes to be written
unsigned char FAR*	pData	;	Write data storage buffer pointer
Return Values			
Returns the write result.			
EEP_OK		;	Successful operation
EEP_ERR_PARAM		;	Parameter error
EEP_ERR_HARD		;	Hardware error
EEP_ERR_WP		;	Write-protection error
EEP_ERR_OTHER		;	Other error
Operations			
<ul style="list-style-type: none"> Writes data to EEPROM in bytes. Writes data from the specified address for the specified number of bytes. 			
Notes			
<ul style="list-style-type: none"> EEPROM can be written to only when write-protection has been canceled. The maximum write address is EEPROM size – 1. 			

In a write to the serial EEPROM, the page rewrite method is used. The original data is divided into the page-unit data and then written to the EEPROM.



2.2.5 Status Read Processing

Function Name
Status read processing signed short eep_Read_Status(unsigned char DevNo, unsigned char * pStatus)
Arguments
unsigned char DevNo ; Device number unsigned char FAR* pStatus ; Read status storage buffer
Return Values
Returns the status register acquisition result. EEP_OK ; Successful operation EEP_ERR_PARAM ; Parameter error EEP_ERR_HARD ; Hardware error EEP_ERR_OTHER ; Other error
Operations
<ul style="list-style-type: none"> • Reads the status. Reads from the status register. • The following information is stored in the read status storage buffer (pStatus). Memory size ≤ 512 bytes <ul style="list-style-type: none"> Bits 7 to 4: Reserved (All 1) Bits 3, 2: BP1, BP0 00: No protection 01: Upper-quarter protection 10: Upper-half protection 11: Whole memory protection Bit 1: WEL 0: Write disabled 1: Write enabled Bit 0: WIP 1: During write operation Memory size > 512 bytes <ul style="list-style-type: none"> Bit 7: SRWD 0: Status register can be changed 1: Status register cannot be changed Bits 6 to 4: Reserved (All 0) Bits 3, 2: BP1, BP0 00: No protection 01: Upper-quarter protection 10: Upper-half protection 11: Whole memory protection Bit 1: WEL 0: Write disabled 1: Write enabled Bit 0: WIP 1: During write operation
Notes
None



2.3 Return Value Definition

```

#define EEP_OK          (signed short)( 0)          /* Successful operation      */
#define EEP_ERR_PARAM  (signed short)(-1)         /* Parameter error          */
#define EEP_ERR_HARD   (signed short)(-2)         /* Hardware error           */
#define EEP_ERR_WP     (signed short)(-3)         /* Write-protection error   */
#define EEP_ERR_OTHER  (signed short)(-4)         /* Other error              */
  
```

2.4 User Setting Examples

Setting examples when using the Renesas Technology MCU SH7206 are shown below.

The location where a setting should be made is indicated by the comment of `/** SET **/` in each file.

2.4.1 eep.h

(1) Definition of the number of devices used and device numbers

Specify the number of devices to be used and assign a number for each device.

In the example below, one device is used and 0 is assigned as the device number.

When using three or more, `eep_io.h` needs to be modified in addition to this file.

```

/**-----*/
/* Define the number of the required serial EEPROM devices.(1 to N devices)      */
/* Define the device number in accordance with the number of serial EEPROM      */
/* devices to be connected.                                                       */
/**-----*/
/* Define number of devices */
#define EEP_DEV_NUM          1  /* 1 device                                     */

/* Define No. of slots */
#define EEP_DEV0             0   /* Device 0                               */
#define EEP_DEV1             1   /* Device 1                               */

```

(2) Definition of size of device used

Specify the size of the device to be used.

In the example below, a 256-Kbit device is used.

```

/**-----*/
/* Define the serial EEPROM device.                                              */
/**-----*/
/*#define EEP_SIZE_002K          /* 2 Kbits(256 bytes)                       */
/*#define EEP_SIZE_004K          /* 4 Kbits(512 bytes)                       */
/*#define EEP_SIZE_008K          /* 8 Kbits( 1 Kbyte)                        */
/*#define EEP_SIZE_016K          /* 16 Kbits( 2 Kbytes)                      */
/*#define EEP_SIZE_032K          /* 32 Kbits( 4 Kbytes)                      */
/*#define EEP_SIZE_064K          /* 64 Kbits( 8 Kbytes)                      */
/*#define EEP_SIZE_128K          /* 128 Kbits( 16 Kbytes)                   */
#define EEP_SIZE_256K           /* 256 Kbits( 32 Kbytes)                   */

```

2.4.2 eep_sfr.h

(1) Definition of header

Specify the header corresponding to the MCU to be used.

In the example below, the SH7206 is used.

If the header is not included, add the header and also create eep_sfr.h.xxx for each MCU with reference to the provided program.

```
//#include "Eep_sfr.h.3029" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.36049" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.36064" /* EEPROM driver SFR common definitions */
//include "Eep_sfr.h.38024" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.38076" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.2378" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.1657" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.1650" /* EEPROM driver SFR common definitions */
//#include "Eep_sfr.h.7149" /* EEPROM driver SFR common definitions */
#include "Eep_sfr.h.7206" /* EEPROM driver SFR common definitions */
```

2.4.3 eep_sfr.h.xxx (File Prepared for Each Group)

The sample program shows a description example in which channel 0 is used as the resource of the clock synchronous SCI.

No setting needs to be modified when the above resource is used.

(1) UART resource

```
/*----- UART definitions -----*/
#ifndef EEP_UART_USED
#define EEP_UART_MSTP CPG.STBCR4.BIT.MSTP44 /* UART module stop control flag */

#define EEP_UART_SMR SCIF3.SCSMR.WORD /* UART serial mode register */
#define EEP_UART_SCR SCIF3.SCSCR.WORD /* UART serial control register */
#define EEP_UART_FSR SCIF3.SCFSR.WORD /* UART serial status register */
#define EEP_UART_BRR SCIF3.SCBRR.BYTE /* UART bit rate register */
#define EEP_UART_FCR SCIF3.SCFCR.WORD /* UART FIFO control register */
#define EEP_UART_SPTR SCIF3.SCSPTR.WORD /* UART serial port register */
#define EEP_UART_LSR SCIF3.SCLSR.WORD /* UART line status register */
#define EEP_UART_TXBUF SCIF3.SCFDR.BYTE /* UART transmit FIFO data register */
#define EEP_UART_RXBUF SCIF3.SCFRDR.BYTE /* UART receive FIFO data register */

#define EEP_UART_ORER SCIF3.SCLSR.BIT.ORER /* UART overrun error flag */

#define EEP_UART_TXEND SCIF3.SCFSR.BIT.TEND /* UART transmit end flag */
#define EEP_UART_TXNEXT SCIF3.SCFSR.BIT.TDFE /* UART transmit FIFO data empty */
#define EEP_UART_RXNEXT SCIF3.SCFSR.BIT.RDF /* UART receive FIFO data full */
```

If another resource is used, make additions or modify the above program. Accordingly, also make additions or modify the /* UART setting */ definition with reference to section 1.5, SuperH Register Setting (Clock Synchronous SCI).

2.4.4 eep_io.h

(1) Definition of header

Specify the header corresponding to the MCU to be used.

In the example below, the SH7206 is used.

If the header is not included, add the header and also create eep_io.h.xxx for each MCU with reference to the provided program.

```
//#include "Eep_io.h.3029"      /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.36049"    /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.36064"    /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.38024"    /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.38076"    /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.2378"     /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.1657"     /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.1650"     /* EEPROM driver I/O module common definitions */
//#include "Eep_io.h.7149"     /* EEPROM driver I/O module common definitions */
#include "Eep_io.h.7206"      /* EEPROM driver I/O module common definitions */
```

2.4.5 eep_io.h.xxx (File Prepared for Each Group)

(1) Definition of resources used by UART of MCU used

Specify the resources of the MCU to be used.

In the example below, the clock synchronous SCI is used.

```

/*-----*/
/* Define the combination of the MCU's resources. */
/*-----*/
#define EEP_OPTION_1          /* Low speed          */          /* UART          */

```

(2) Definition of control ports of MCU used

Specify the control ports of the MCU to be used.

In the example below, RxD, TxD, and SCK of the clock synchronous SCI and CS# are assigned.

When two devices are connected, make a definition regarding CS1.

When using three or more, eep.h needs to be modified in addition to this file.

```

/*-----*/
/* Define the control port. */
/*-----*/

#define EEP_P_DATAO          PORT.PEDRL.BIT.PE12DR          /* EEP DataOut          */
#define EEP_P_DATAI          PORT.PEDRL.BIT.PE11DR          /* EEP DataIn           */
#define EEP_P_CLK            PORT.PEDRL.BIT.PE9DR           /* EEP CLK              */
#define EEP_D_DATAO          PORT.PEIORL.BIT.PE12IOR        /* EEP DataOut          */
#define EEP_D_DATAI          PORT.PEIORL.BIT.PE11IOR        /* EEP DataIn           */
#define EEP_D_CLK            PORT.PEIORL.BIT.PE9IOR         /* EEP CLK              */
#define EEP_PCR_DATAO        PORT.PECRL4.BIT.PE12MD        /* EEP DataOut          */
#define EEP_PCR_DATAI        PORT.PECRL3.BIT.PE11MD        /* EEP DataIn           */
#define EEP_PCR_CLK          PORT.PECRL3.BIT.PE9MD         /* EEP CLK              */

#define EEP_P_CS0            PORT.PEDRL.BIT.PE15DR          /* EEP CS0 (Negative-true logic) */
#define EEP_D_CS0            PORT.PEIORL.BIT.PE15IOR        /* EEP CS0 (Negative-true logic) */
#define EEP_PCR_CS0          PORT.PECRL4.BIT.PE15MD        /* EEP CS0 (Negative-true logic) */
#if (EEP_DEV_NUM > 1)
#define EEP_P_CS1            /* EEP CS1 (Negative-true logic) */
#define EEP_D_CS1            /* EEP CS1 (Negative-true logic) */
#define EEP_PCR_CS1         /* EEP CS1 (Negative-true logic) */
#endif /* #if (EEP_DEV_NUM > 1) */

```

2.4.6 mtl_com.h (Common Header File)

(1) Definition of header

Specify the header corresponding to the MCU to be used.

In the example below, the SH7206 is used.

If the header is not included, add the header and also create mtl_com.h.xxx for each MCU with reference to the provided program.

```
#include "mtl_com.h.7206"
```

2.4.7 mtl_com.h.xxx (File Prepared for Each Group)

Setting examples when using the SH7206 are shown below.

(1) Definition of OS header file

This software is an OS-independent program.

In the example below, the OS is not used.

```
/* Include an OS header file with a prototype declaration */ /** SET **/
/* because wai_sem/sig_sem/dly_tsk is used. */ /** SET **/
/* The define and include statements below should be */ /** SET **/
/* comments when the OS is not used. */ /** SET **/
// #define MTL_OS_USE /* OS usage */ /** SET **/
// #include <mr30.h> /* OS include file */ /** SET **/
```

(2) Definition of header file specifying common access area

Includes the header file in which the MCU registers are defined.

This file needs to be included because it is mainly used by the device driver for controlling the ports.

In the example below, the SH7206 header file is included. Include the header file in accordance with the MCU.

```
/* Include the header file containing the define statement */ /** SET **/
/* for the I/O periphery because the define value of the */ /** SET **/
/* SFR area of the MCU is used. */ /** SET **/
#include "7206.h" /* SH7206 include file */ /** SET **/
```

(3) Definition of endian type

This is a setting for another purpose. Do not modify the definition.

```

/* Specify the endian type of the MCU used. */ /** SET **/
/* When big endian is specified, little endian definition should be a comment. */ /** SET **/
#define MTL_MCU_LITTLE /* Little endian */ /** SET **/

```

(4) Specification of standard library type used

This is a setting for another purpose. Do not modify the specification.

```

/* Specify the standard library type used. */ /** SET **/
/* When the processing below is used in the library provided with the */ /** SET **/
/* compiler, the define statement below should be a comment. */ /** SET **/
/* memcmp() / memcpy() / memset() / strcat() / strcmp() / strcpy() / strlen() */ /** SET **/
#define MTL_USER_LIB /* Optimized library usage */ /** SET **/

```

(5) Definition of RAM area accessed by processing group used

Define MTL_MEM_NEAR for the SuperH family.

```

/* Define the RAM area accessed by the processing group used. */ /** SET **/
/* Standard function or processing efficient for some */ /** SET **/
/* processing is applied. */ /** SET **/
#define MTL_MEM_FAR /* Supports even external RAM area */ /** SET **/
#define MTL_MEM_NEAR /* Supports only internal RAM area */ /** SET **/

```

Set only the above define statement and do not make any other modifications.

(6) Definition of software timer

Sets the internal software timer used.

Make this setting in accordance with the system.

The following reference values are obtained at 16.67-MHz operation without wait and when the instruction cache is disabled.

Note that the settings differ when the instruction cache is enabled and so that the setting should be made in accordance with the system.

```

/*----- */
/* Define the counter value of the timer. */
/* Note: Calculated at 16.67-MHz operation. */
#define MTL_T_1US          28          /* 1-us loop count */
#define MTL_T_2US          64          /* 2-us loop count */
#define MTL_T_4US          138         /* 4-us loop count */
#define MTL_T_5US          174         /* 5-us loop count */
#define MTL_T_10US         358         /* 10-us loop count */
#define MTL_T_20US         724         /* 20-us loop count */
#define MTL_T_30US         1090        /* 30-us loop count */
#define MTL_T_50US         1823        /* 50-us loop count */
#define MTL_T_100US        3655        /* 100-us loop count */
#define MTL_T_200US        7320        /* 200-us loop count */
#define MTL_T_300US        10990       /* 300-us loop count */
#define MTL_T_400US        ( MTL_T_200US * 2 ) /* 400-us loop count */
#define MTL_T_1MS          36650       /* 1-ms loop count */
// #define MTL_T_2MS        ( MTL_T_1MS * 2 ) /* 2-ms loop count */
// #define MTL_T_5MS        ( MTL_T_1MS * 5 ) /* 5-ms loop count */

```

2.5 Usage Notes

The sample programs show description examples in which the clock synchronous SCI is used.

When using another resource, set the software in accordance with the hardware.

2.6 Notes at Embedment

To embed the sample programs, include eep.h.

2.7 Usage of Another SuperH Family MCU

Usage of another SuperH family MCU is supported easily.

The following files must be prepared.

- (1) I/O module common definition equivalent of eep_io.h.xxx
Define the I/O pins to be used with reference to the SFR header of the MCU used.
- (2) SFR common definition equivalent of eep_sfr.h.xxx
Define the UART to be used with reference to the SFR header of the MCU used.
- (3) Header definition equivalent of mtl_com.h.xxx
Create and define a header for the MCU used.

Create the above files with reference to the provided programs.

In addition, specify the created header in eep_io.h, eep_sfr.h, and mtl_com.h.

2.8 File Configuration

\com	<DIR>	Directory for common functions	
	mtl_com.c	mtl_com.h	Various definitions for common functions
	mtl_com.h.1650		Common header file
	mtl_com.h.1657		Common header file
	mtl_com.h.2378		Common header file
	mtl_com.h.3029		Common header file
	mtl_com.h.36049		Common header file
	mtl_com.h.38024		Common header file
	mtl_com.h.38076		Common header file
	mtl_com.h.7149		Common header file
mtl_com.h.7206		Common header file	
\drv	<DIR>	Sample device driver directory	
	\seep_spi <DIR>	Serial EEPROM directory	
	eep.h		Driver common definition
	eep_usr.c		Driver user I/F module
	eep_io.c	eep_io.h	I/O module
	eep_io.h.1650		I/O module common definition
	eep_io.h.1657		I/O module common definition
	eep_io.h.2378		I/O module common definition
	eep_io.h.3029		I/O module common definition
	eep_io.h.36049		I/O module common definition
	eep_io.h.38024		I/O module common definition
	eep_io.h.38076		I/O module common definition
	eep_io.h.7149		I/O module common definition
	eep_io.h.7206		I/O module common definition
	eep_sfr.h		SFR common definition
	eep_sfr.h.1650		SFR common definition
	eep_sfr.h.1657		SFR common definition
	eep_sfr.h.2378		SFR common definition
	eep_sfr.h.3029		SFR common definition
	eep_sfr.h.36049		SFR common definition
	eep_sfr.h.38024		SFR common definition
	eep_sfr.h.38076		SFR common definition
eep_sfr.h.7149		SFR common definition	
eep_sfr.h.7206		SFR common definition	
\sample	<DIR>	Sample program directory	
	usr_tst tsk.c		Sample program for operation verification Use this for operation verification.
	tsk.c	tsk.h	Various definitions for common functions
	common.c	common.h	Various definitions for common functions

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Dec.15.06	—	First edition issued

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